

November 2001 Revised November 2001

74ALVC16841

Low Voltage 20-Bit Transparent Latch with 3.6V Tolerant Inputs and Outputs

General Description

The ALVC16841 contains twenty non-inverting latches with 3-STATE outputs and is intended for bus oriented applications. The device is byte controlled. The flip-flops appear transparent to the data when the Latch enable (LE) is HIGH. When LE is LOW, the data that meets the setup time is latched. Data appears on the bus when the Output Enable (\overline{OE}) is LOW. When \overline{OE} is HIGH, the outputs are in a high impedance state.

The 74ALVC16841 is designed for low voltage (1.65V to 3.6V) V_{CC} applications with I/O compatibility up to 3.6V.

The 74ALVC16841 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining low CMOS power dissipation.

Features

- 1.65V-3.6V V_{CC} supply operation
- 3.6V tolerant inputs and outputs
- \blacksquare t_{PD} (D_n to O_n)
 - 3.5 ns max for 3.0V to 3.6V V_{CC} 3.9 ns max for 2.3V to 2.7V V_{CC}
 - 6.8 ns max for 1.65V to 1.95V V_{CC}
- Power-off high impedance inputs and outputs
- Supports live insertion and withdrawal (Note 1)
- Uses patented noise/EMI reduction circuitry
- Latchup conforms to JEDEC JED78
- ESD performance:

Human body model > 2000V Machine model > 200V

Note 1: To ensure the high-impedance state during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pull-up resistor; the minimum value of the resistor is determined by the current-sourcing capability of the distance.

Ordering Code:

Order Number	Package Number	Package Description
74ALVC16841MTD	MTD56	56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code

Logic Symbol



Pin Descriptions

Pin Names	Description
ŌĒn	Output Enable Input (Active LOW)
LE _n	Latch Enable Input
D ₀ -D ₁₉	Inputs
O ₀ -O ₁₉	Outputs



Connection Diagram

OE ₁	1	\cup	56	LE,
00 -	2		55	_ D ₀
0, -	3		54	— D ₁
GND -	4		53	— GNE
02 -	5		52	— D ₂
03 -	6		51	— D ₃
v _{cc} —	7		50	- v _{cc}
04 —	8		49	- D4
05 —	9		48	— D ₅
06 -	10		47	— D ₆
GND -	11		46	— GNE
07 -	12		45	— D ₇
08 —	13		44	— D ₈
o ₉ —	14		43	— D ₉
010 -	15		42	— D ₁₀
011	16		41	— D _{1 1}
012 -	17		40	— D ₁₂
GND -	18		39	— GNE
013 -	19		38	- D ₁₃
014 -	20		37	— D _{1.4}
015 —	21		36	— D ₁₅
v _{cc} —	22		35	— v _{cc}
0,6	23		34	— D ₁₆
017 -	24		33	— D ₁₇
GND -	25		32	— GNE
018 -	26		31	— D ₁₈
019 —	27		30	— D ₁₉
ŌE ₂ —	28		29	- LE ₂
				•

Truth Tables

	Inputs		Outputs
LE ₁	OE ₁	D ₀ -D ₉	O ₀ -O ₉
Х	Н	Х	Z
Н	L	L	L
Н	L	Н	Н
L	L	Х	O ₀

	Inputs		Outputs
LE ₂	OE ₂	D ₁₀ -D ₁₉	O ₁₀ -O ₁₉
Х	Н	Х	Z
Н	L	L	L
Н	L	Н	Н
L	L	Χ	O_0

- H = HIGH Voltage Level
- The High Voltage Level

 X = Immaterial (HIGH or LOW, inputs may not float)

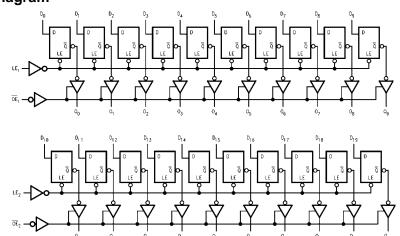
 Z = High Impedance
- O₀ = Previous O₀ before HIGH-to-LOW of Latch Enable

Functional Description

The 74ALVC16841 contains twenty D-type latches with 3-STATE outputs. The device is byte controlled with each byte functioning identically, but independent of the other. Control pins can be shorted together to obtain full 20-bit operation. The following description applies to each byte. When the Latch Enable (LE_n) input is HIGH, data on the D_n enters the latches. In this condition the latches are transparent, i.e., a latch output will change states each time its

D-type input changes. When LE_n is LOW, the latches store information that was present on the D-type inputs a setup time preceding the HIGH-to-LOW transition on $\rm LE_n$. The 3-STATE outputs are controlled by the Output Enable (\overline{OE}_n) input. When \overline{OE}_n is LOW the standard outputs are in the 2-state mode. When $\overline{\text{OE}}_{\text{n}}$ is HIGH, the standard outputs are in the high impedance mode but this does not interfere with entering new data into the latches.

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays

1.65V to 3.6V

-40°C to +85°C

0V to V_{CC}

0V to $V_{\mbox{\footnotesize CC}}$

10 ns/V

Absolute Maximum Ratings(Note 2)

Supply Voltage (V_{CC}) -0.5V to +4.6V

DC Input Voltage (V_I) -0.5V to 4.6V

Output Voltage (V_O) (Note 3) -0.5V to V_{CC} +0.5V DC Input Diode Current (I_{IK})

 $V_I < 0V$ -50 mA

DC Output Diode Current (I_{OK})

Storage Temperature Range (T_{STG})

-50 mA $V_O < 0V$

DC Output Source/Sink Current (I_{OH}/I_{OL}) ±50 mA

DC V_{CC} or GND Current per

Supply Pin (I_{CC} or GND) ±100 mA

Note 2: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the condi--65°C to +150°C tions for actual device operation.

Note 3: I_O Absolute Maximum Rating must be observed.

Recommended Operating

Free Air Operating Temperature (T_A)

Minimum Input Edge Rate (Δt/ΔV)

 $V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$

Conditions (Note 4)

Power Supply

Operating

Input Voltage (V_I)

Output Voltage (V_O)

Note 4: Floating or unused inputs must be held HIGH or LOW.

DC Electrical Characteristics

Symbol	Parameter	Conditions	V _{CC}	Min	Max	Units
V _{IH}	HIGH Level Input Voltage		1.65 -1.95	0.65 x V _{CC}		
			2.3 - 2.7	1.7		V
			2.7 - 3.6	2.0		
V _{IL}	LOW Level Input Voltage		1.65 -1.95		0.35 x V _{CC}	
			2.3 - 2.7		0.7	V
			2.7 - 3.6		0.8	
V _{OH}	HIGH Level Output Voltage	$I_{OH} = -100 \mu A$	1.65 - 3.6	V _{CC} - 0.2		
		$I_{OH} = -4 \text{ mA}$	1.65	1.2		
		$I_{OH} = -6 \text{ mA}$	2.3	2		
		$I_{OH} = -12 \text{ mA}$	2.3	1.7		V
			2.7	2.2		
			3.0	2.4		
		$I_{OH} = -24 \text{ mA}$	3.0	2		
V _{OL}	LOW Level Output Voltage	I _{OL} = 100 μA	1.65 - 3.6		0.2	
		$I_{OL} = 4 \text{ mA}$	1.65		0.45	
		$I_{OL} = 6 \text{ mA}$	2.3		0.4	V
		$I_{OL} = 12mA$	2.3		0.7	V
			2.7		0.4	
		$I_{OL} = 24 \text{ mA}$	3		0.55	
l _l	Input Leakage Current	0 ≤ V _I ≤ 3.6V	3.6		±5.0	μΑ
l _{oz}	3-STATE Output Leakage	0 ≤ V _O ≤ 3.6V	3.6		±10	μΑ
lcc	Quiescent Supply Current	$V_I = V_{CC}$ or GND, $I_O = 0$	3.6		40	μΑ
Δl _{CC}	Increase in I _{CC} per Input	$V_{IH} = V_{CC} - 0.6V$	3 -3.6		750	μΑ

AC Electrical Characteristics

		T _A = -40° C to $+85^{\circ}$ C, R _L = 500Ω								
Symbol	Symbol Parameter C _L = 50 pF C _L = 30	30 pF	pF							
Symbol	rarameter	V _{CC} = 3.3	3V ± 0.3V	V _{CC}	= 2.7V	V _{CC} = 2.	5V ± 0.2V	V _{CC} = 1.8	3V ± 0.15V	Units
		Min	Max	Min	Max	Min	Max	Min	Max	
t _{PHL} , t _{PLH}	Propagation Delay	1.3	3.5	1.5	3.9	1.0	3.4	1.5	6.8	ns
	Bus to Bus	1.3	3.3	1.5	5.5	1.0	0.4	1.5	0.0	110
t _{PHL} , t _{PLH}	Propagation Delay	1.3	4.0	1.5	4.9	1.0	4.4	1.5	8.8	ns
	LE to Bus	1.0	4.0	1.0	4.0	1.0	1.4	1.0	0.0	110
t _{PZL} , t _{PZH}	Output Enable Time	1.3	4.3	1.5	5.4	1.0	4.9	1.5	9.8	ns
t_{PLZ},t_{PHZ}	Output Disable Time	1.3	4.2	1.5	4.7	1.0	4.2	1.5	7.6	ns
t _W	Pulse Width	1.5		1.5		1.5		4.0		ns
t _S	Setup Time	1.5		1.5		1.5		2.5		ns
t _H	Hold Time	1.0		1.0		1.0		1.0		ns

Capacitance

Symbol	Parameter		Conditions	T _A = -	Units	
Symbol		Conditions	v _{cc}	Typical		
C _{IN}	Input Capacitance		$V_I = 0V \text{ or } V_{CC}$	3.3	6	pF
C _{OUT}	Output Capacitance		V _I = 0V or V _{CC}	3.3	7	pF
C _{PD}	Power Dissipation Capacitance Outputs Enabled		$f = 10 \text{ MHz}, C_L = 50 \text{ pF}$	3.3	20	pF
				2.5	20	ρı

AC Loading and Waveforms

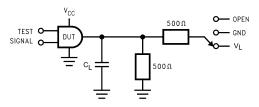


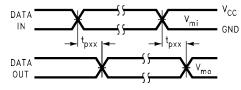
TABLE 1. Values for Figure 1

TEST	SWITCH
t _{PLH} , t _{PHL}	Open
t_{PZL}, t_{PLZ}	V_L
t_{PZH} , t_{PHZ}	GND

FIGURE 1. AC Test Circuit

TABLE 2. Variable Matrix (Input Characteristics: f= 1MHz; $t_r=t_f=$ 2ns; ${\bf Z}_0=$ 50 $\!\Omega$)

Symbol	V _{CC}							
	$3.3V \pm 0.3V$	2.7V	$\textbf{2.5V} \pm \textbf{0.2V}$	$\textbf{1.8V} \pm \textbf{0.15V}$				
V_{mi}	1.5V	1.5V	V _{CC} /2	V _{CC} /2				
V _{mo}	1.5V	1.5V	V _{CC} /2	V _{CC} /2				
V _X	V _{OL} + 0.3V	V _{OL} + 0.3V	V _{OL} + 0.15V	V _{OL} + 0.15V				
V _Y	V _{OH} – 0.3V	V _{OH} – 0.3V	V _{OH} – 0.15V	V _{OH} – 0.15V				
Vı	6V	6V	V _{CC} *2	V _{CC} *2				



OUTPUT CONTROL V_{mi} GND GND DATA OUT

FIGURE 2. Waveform for Inverting and Non-Inverting Functions

FIGURE 3. 3-STATE Output High Enable and Disable Times for Low Voltage Logic

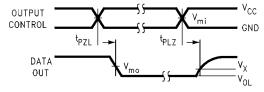


FIGURE 4. 3-STATE Output Low Enable and Disable Times for Low Voltage Logic

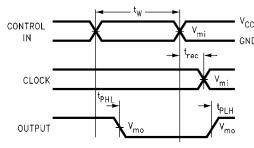


FIGURE 5. Propagation Delay, Pulse Width and $\rm t_{\rm rec}$ Waveforms

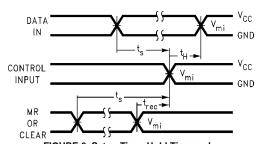
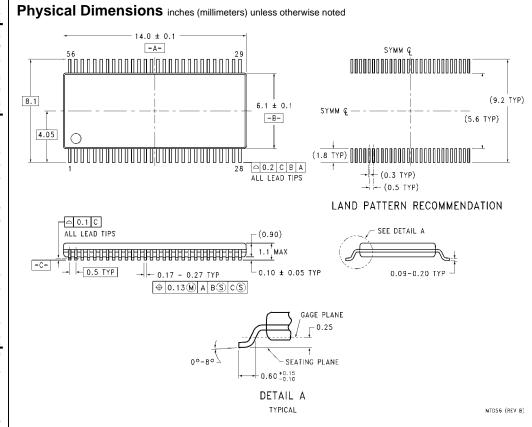


FIGURE 6. Setup Time, Hold Time and Recovery Time for Low Voltage Logic



56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Package Number MTD56

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